

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

Description

The HCS03FS140HDA1S is a 3 Phase SiC MOSFET Power Module. It integrates high performance SiC MOSFET chips for xEV or motor drives application.



Features

- Blocking Voltage 1400V
- $R_{DS(on)}=3.2m\Omega$ ($T_j=25^\circ C$)
- 175°C Maximum Junction Temperature
- Si₃N₄ AMB Substrate
- Direct Cooled Pin Fin Base Plate
- Thermistor Inside
- Press FIT Contact Technology

Application

- xEV Applications
- Motor Drives

Circuit Diagram

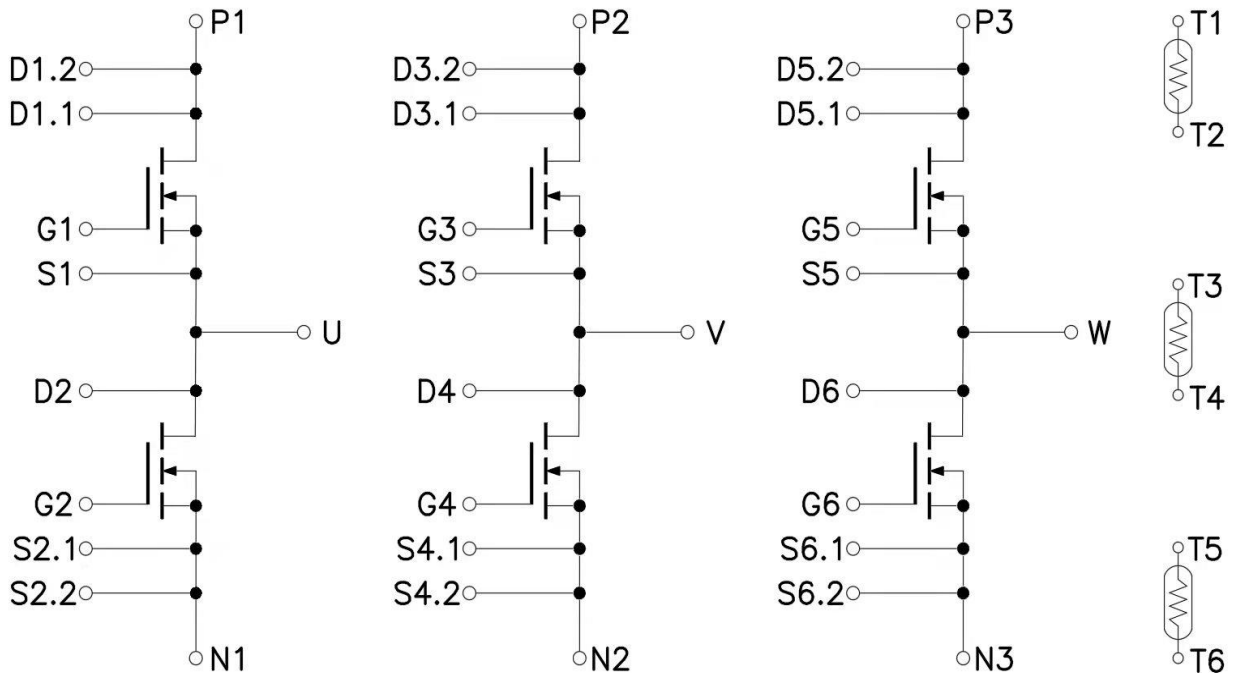


Figure 1. Out Drawing & Circuit Diagram HCS03FS140HDA1S

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

Physical Dimensions

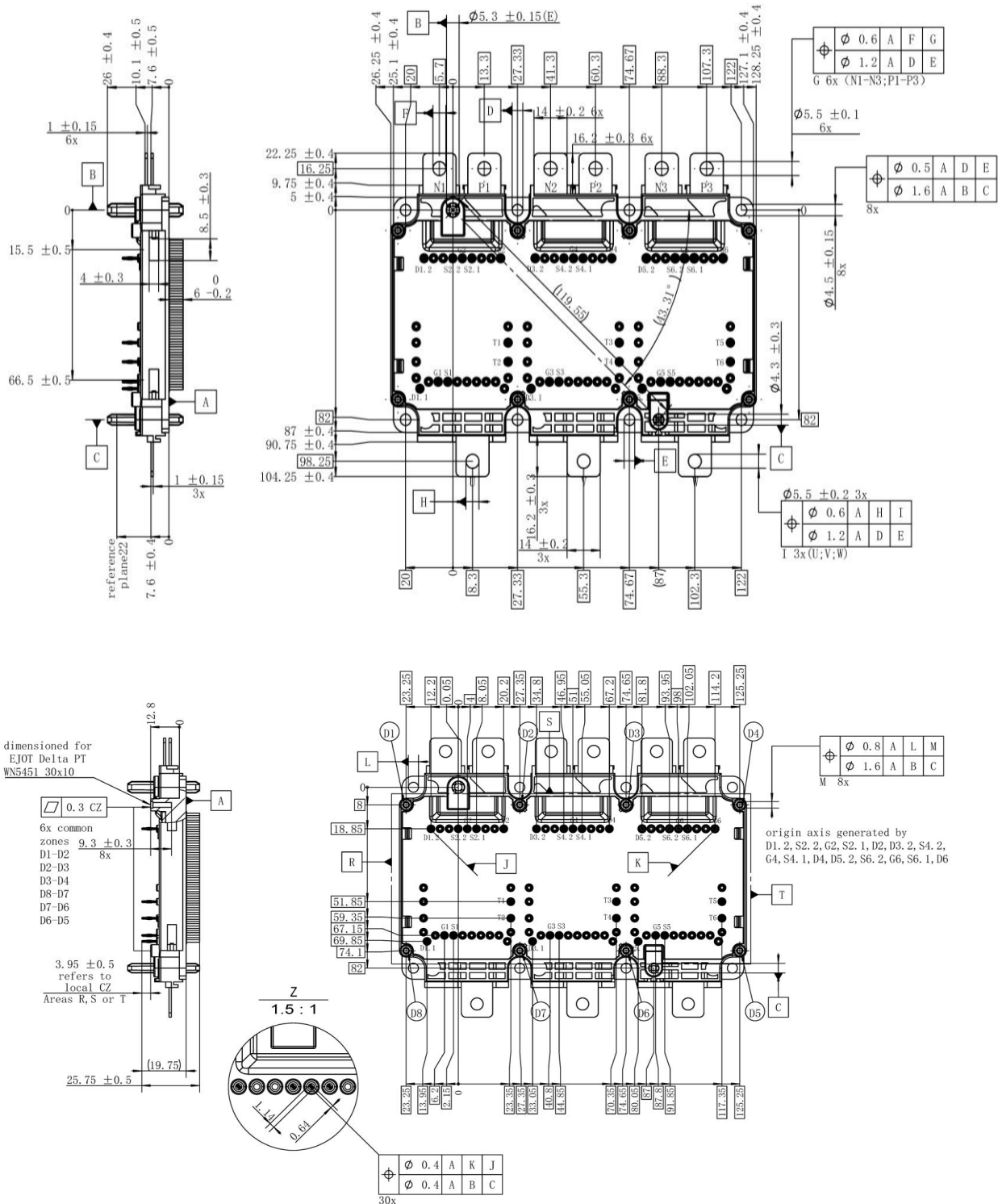


Figure 2. Physical Dimensions

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

Maximum Ratings ($T_j=25^\circ\text{C}$ Unless Otherwise Specified)

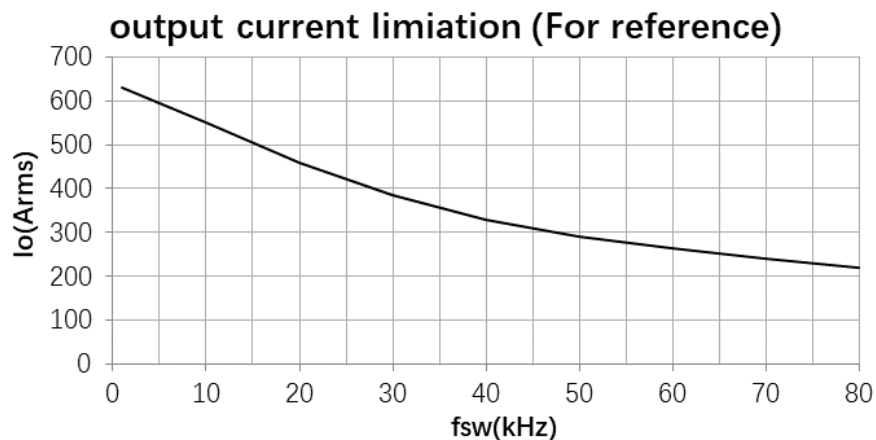
Symbol	Parameter	Conditions	Value	Unit
V_{DSS}	Drain-Source Voltage	G-S Short	1400	V
$V_{DS\ nom}$	Continuous Operating DC Voltage	Not include surge voltage	1200	V
V_{GSS}	Gate-Source Voltage	D-S Short, AC frequency • 4Hz, Note1	-10V/+25V	V
I_{DS}	DC Continuous Drain Current	$T_f=25^\circ\text{C}$, $V_{GS}=20\text{V}$	530	A
I_{DS}	DC Continuous Drain Current	$T_f=65^\circ\text{C}$, $V_{GS}=20\text{V}$	460	A
I_{SD}	Source (Body Diode) Current	$T_f=25^\circ\text{C}$, with ON signal	530	A
I_{SD}	Source (Body Diode) Current	$T_f=65^\circ\text{C}$, with ON signal	460	A
I_{DP}	Drain Pulse Current, Peak	Less than 1ms, Note2	1200	A
P_D	Maximum Power Dissipation	$T_f=25^\circ\text{C}$	1785	W
T_j	Junction temperature	-	-40 to 175	$^\circ\text{C}$
T_{stg}	Storage temperature	-	-40 to 125	$^\circ\text{C}$

Note1: Recommended Operating Value: +20V/-5V, +20V/-4V, +18V/-4V, +15V/-4V

Note2: Pulse width limited by maximum junction temperature

Typical Current Output Ability

Condition: SPWM control, $V_{DD}=800\text{V}$, $R_{g(ON)}=R_{g(OFF)}=5\Omega$, $T_f=65^\circ\text{C}$, $T_{jmax}=175^\circ\text{C}$, PF=0.8, Modulation rate=1



Note1: This graph is calculated value for reference based on the limitation of $T_{jmax}=175^\circ\text{C}$. The actual current out ability depends on inverter electrical, thermal and mechanic design. Please confirm it in actual application system.

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

Module

Parameter	Conditions	Value	Unit
Isolation voltage	Main terminal to base plate, f =0Hz, t =1sec	4.0	kV
Material of module baseplate	-	Cu + Ni	-
Creepage distance	terminal to heatsink terminal to terminal	9	mm
Clearance	terminal to heatsink terminal to terminal	4.5	mm
Stray inductance module	$T_f = 65^\circ\text{C}$	8	nH
Module lead resistance, terminals – chip	$T_f = 65^\circ\text{C}$	0.2	m Ω
Mounting torque for module mounting	Screw M4 baseplate to heatsink	1.8 to 2.2	Nm
Weight	-	798	g

NTC Characteristics

Symbol	Parameter	Conditions	Value			Unit
			Min.	Typ.	Max.	
R25	Resistance	$T_c = 25^\circ\text{C}$	-	5	-	k Ω
$\Delta R/R$	Deviation of R_{100}	$T_c = 100^\circ\text{C}$, $R_{100} = 493\Omega$	-5	-	5	%
P_{25}	Power dissipation	$T_c = 25^\circ\text{C}$	-	-	20	mW
$B_{25/50}$	B-value	$R_2 = R_{25} \exp [B_{25/50} (1/T_2 - 1/(298,15 \text{ K}))]$	-	3375	-	K
$B_{25/80}$	B-value	$R_2 = R_{25} \exp [B_{25/80} (1/T_2 - 1/(298,15 \text{ K}))]$	-	3411	-	K
$B_{25/100}$	B-value	$R_2 = R_{25} \exp [B_{25/100} (1/T_2 - 1/(298,15 \text{ K}))]$	-	3433	-	K

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

MOSFET Electrical Characteristics ($T_j=25^\circ\text{C}$ Unless Otherwise Specified, Chip)

Symbol	Parameter	Conditions	Value			Unit	
			Min.	Typ.	Max.		
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=600\mu A$	1400	-	-	V	
I_{DSS}	Zero gate voltage drain current	$V_{DS}=1400V, V_{GS}=0V$	-	60	-	μA	
$V_{GS(Th)}$	Gate-source threshold voltage	$I_D=120mA, V_{DS}=V_{GS}$	$T_j=25^\circ\text{C}$	1.9	2.5	3.8	V
			$T_j=175^\circ\text{C}$	-	1.60	-	V
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=20V, V_{DS}=0V, T_j=25^\circ\text{C}$	-	-	1200	nA	
$R_{DS(on)}$ (Chip)	Static drain-source On-state resistance	$I_D=600A, V_{GS}=20V$	$T_j=25^\circ\text{C}$	-	3.2	-	m Ω
			$T_j=175^\circ\text{C}$	-	6.2	-	m Ω
	Static drain-source On-state resistance	$I_D=600A, V_{GS}=18V$	$T_j=25^\circ\text{C}$	-	3.5	-	m Ω
			$T_j=175^\circ\text{C}$	-	6.5	-	m Ω
$V_{DS(on)}$ (Chip)	Static drain-source On-state resistance	$I_D=600A, V_{GS}=20V$	$T_j=25^\circ\text{C}$	-	1.90	-	V
			$T_j=175^\circ\text{C}$	-	3.7	-	V
		$I_D=600A, V_{GS}=18V$	$T_j=25^\circ\text{C}$	-	2.10	-	V
			$T_j=175^\circ\text{C}$	-	3.9	-	V
C_{iss}	Input capacitance	$V_{DS}=1000V, V_{GS}=0V, f=100kHz$	-	28.62	-	nF	
C_{oss}	Output capacitance		-	1.30	-	nF	
C_{riss}	Reverse transfer capacitance		-	0.10	-	nF	
Q_g	Total gate charge		-	1620	-	nC	
Q_{gs}	Gate to source charge	$V_{DS}=800V, I_D=300A$	-	372	-	nC	
Q_{gd}	Gate to drain charge	$V_{GS}=+20/-5V$	-	468	-	nC	
R_{gint}	Internal gate resistance	$f=1MHz$	-	1.5	-	Ω	
$t_{d(on)}$	Turn-on delay tim	$V_{DD}=800V, I_D=600A, V_{GS}=+18/-4V, R_{G(ON)}=3.3\Omega, R_{G(OFF)}=3.3\Omega$ Inductive load Switching operation	$T_j=25^\circ\text{C}$	-	71	-	ns
t_r	Rise time		$T_j=150^\circ\text{C}$	-	63	-	ns
			$T_j=25^\circ\text{C}$	-	59	-	
$t_{d(off)}$	Turn-off delay time		$T_j=150^\circ\text{C}$	-	48	-	ns
			$T_j=25^\circ\text{C}$	-	48	-	
t_f	Fall time		$T_j=150^\circ\text{C}$	-	30	-	ns
			$T_j=25^\circ\text{C}$	-	41	-	
E_{on}	Turn-on power dissipation		$T_j=25^\circ\text{C}$	-	16.2	-	mJ
			$T_j=150^\circ\text{C}$	-	22.9	-	
E_{off}	Turn-off power dissipation		$T_j=25^\circ\text{C}$	-	4.4	-	mJ
			$T_j=150^\circ\text{C}$	-	7.1	-	
$R_{th(j-f)}$	FET Thermal Resistance		Junction to cooling fluid $\Delta V/\Delta t=10dm^3/min, T_f=65^\circ\text{C}$	-	0.084	-	K/W

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

Body Diode Electrical Characteristics ($T_j=25^\circ\text{C}$ Unless Otherwise Specified, Chip)

Symbol	Parameter	Conditions	Value			Unit	
			Min.	Typ.	Max.		
V_{SD}	Body Diode Forward Voltage	$V_{GS}=-5\text{V}$ $I_{SD}=600\text{A}$	$T_j=25^\circ\text{C}$	-	5.8	-	V
			$T_j=175^\circ\text{C}$	-	5.2	-	
T_{rr}	Reverse Recovery Time	$V_{RR}=800\text{V}$ $I_D=600\text{A}$	$T_j=25^\circ\text{C}$	-	44	-	ns
			$T_j=150^\circ\text{C}$	-	51	-	
Q_{rr}	Reverse Recovery Charge	MOSFET Side: $V_{GS}=+18/-4\text{V}$ $R_{G(ON)}=R_{G(OFF)}=3.3\Omega$	$T_j=25^\circ\text{C}$	-	3.4	-	μC
			$T_j=150^\circ\text{C}$	-	7.3	-	
E_{rr}	Diode Switching Power Dissipation	Inductive loads Switching operation	$T_j=25^\circ\text{C}$	-	0.9	-	mJ
			$T_j=150^\circ\text{C}$	-	2.8	-	

Test Conditions

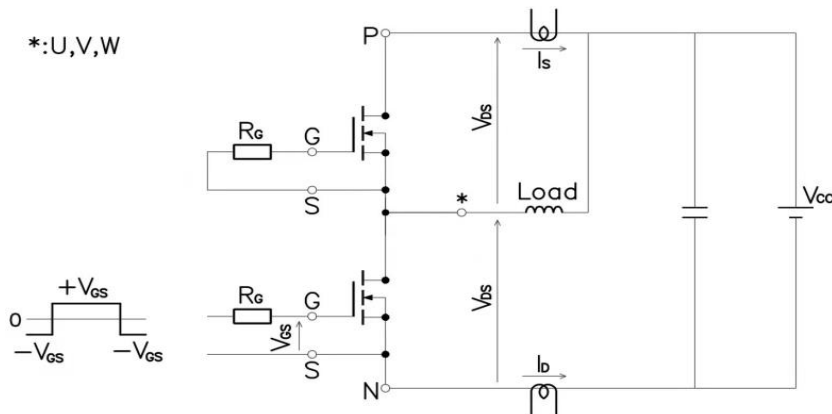


Figure 3. Switching Time Measure Circuit

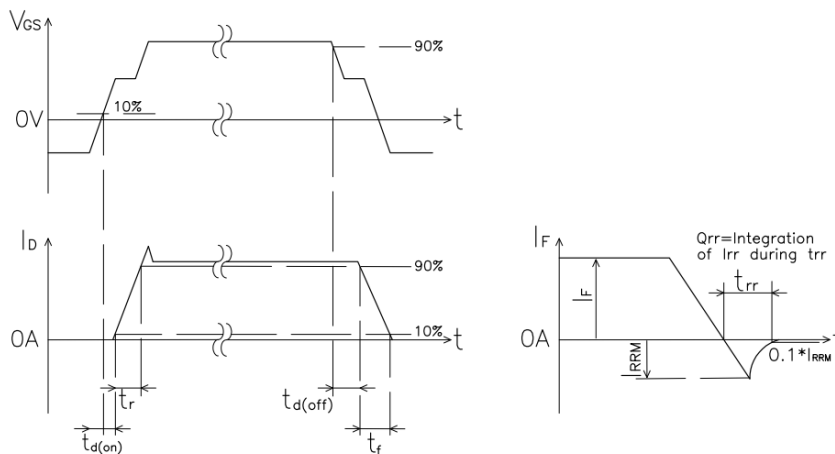


Figure 4. Switching Time Definition

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

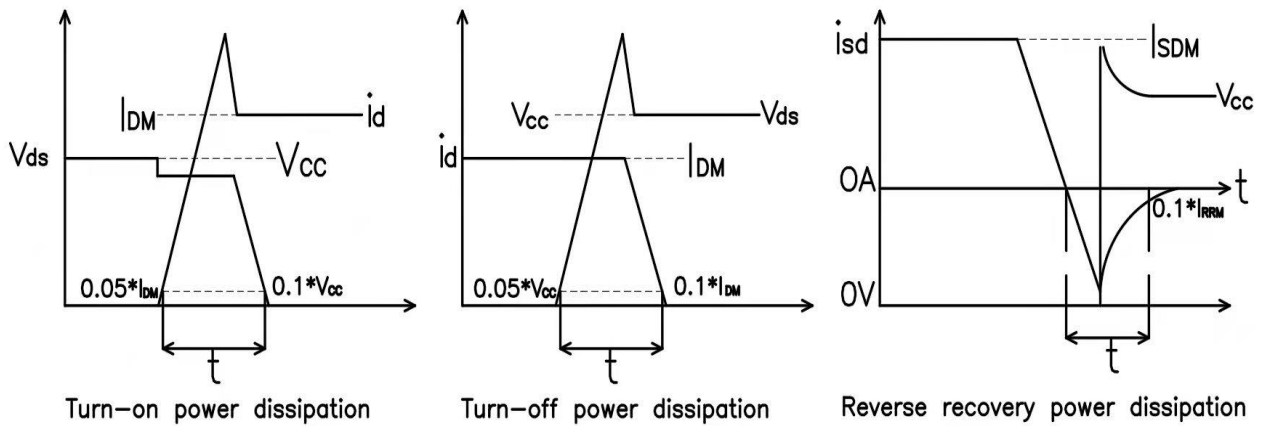


Figure 4. Switching Power Dissipation Definition

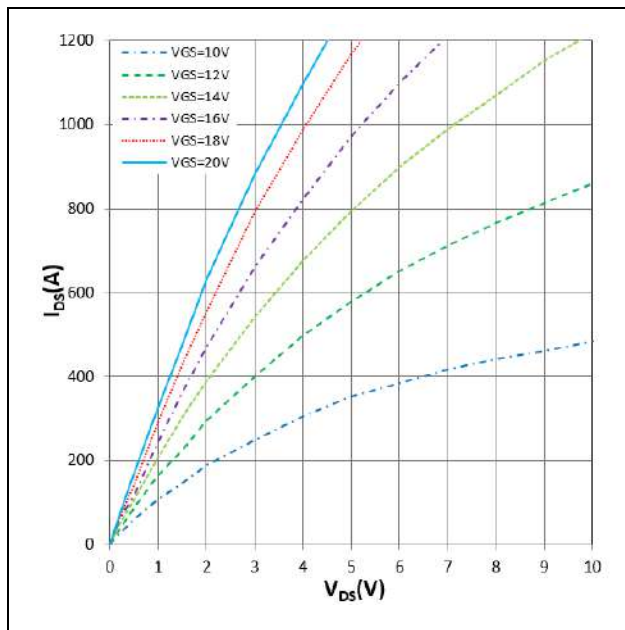


Figure 6. I_{DS} VS V_{DS}
 $T_j = 25^\circ\text{C}$, V_{GS} Parameter

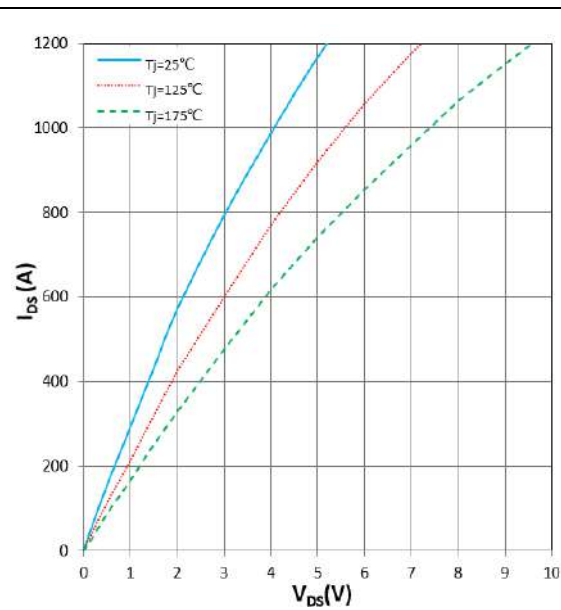


Figure 7. I_{DS} VS V_{DS}
 $V_{GS} = 18\text{V}$, T_j Parameter

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

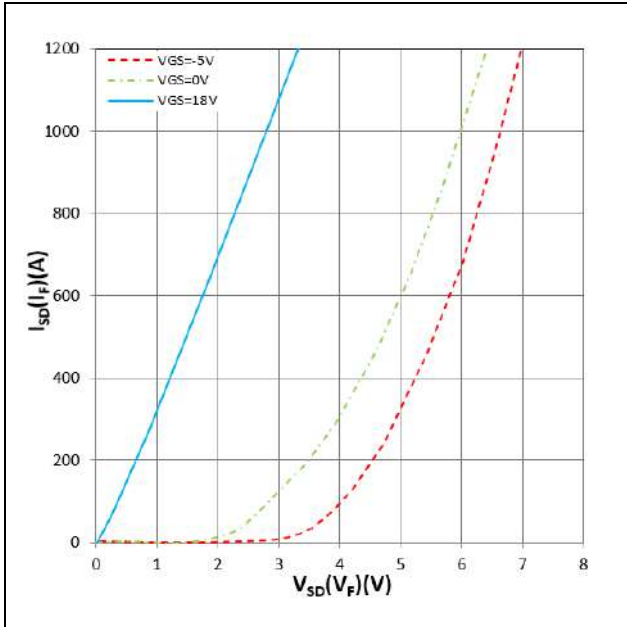


Figure 8. I_{SD} VS V_{SD}
 $T_J=25^{\circ}\text{C}$, V_{GS} Parameter

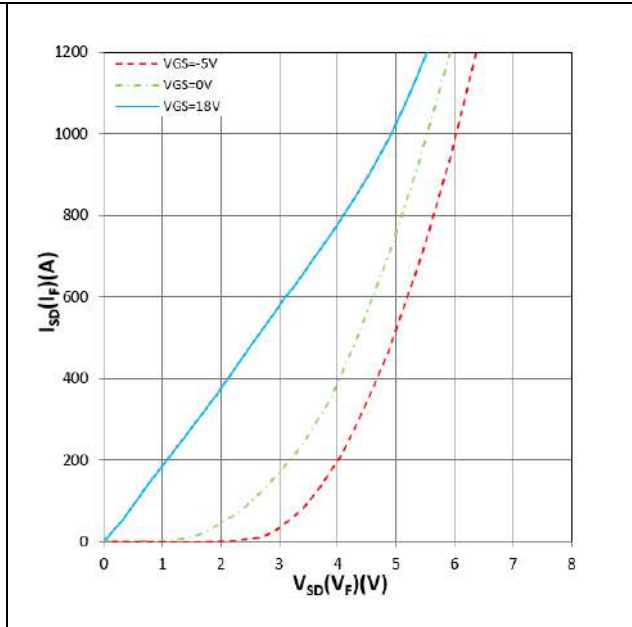


Figure 9. I_{SD} VS V_{SD}
 $T_J=175^{\circ}\text{C}$, V_{GS} Parameter

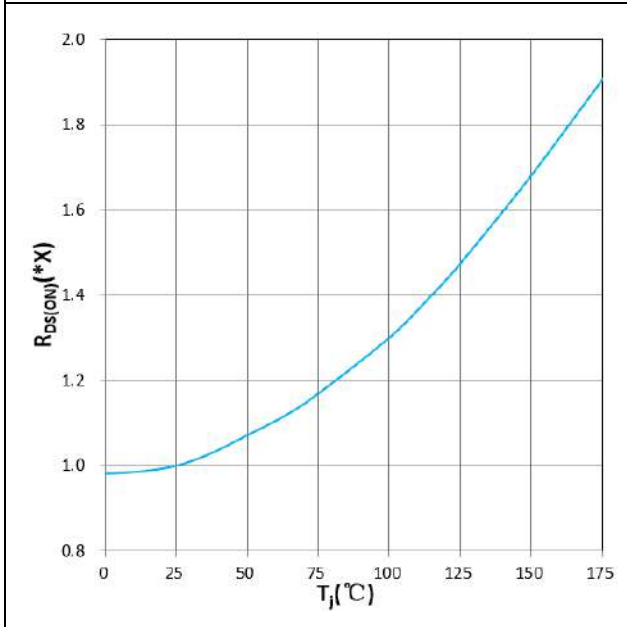


Figure 10. $R_{DS(ON)}$ VS T_J
 $V_{GS}=+20\text{V}$, $I_D=600\text{A}$, $1.0X=3.2\text{m}\Omega$

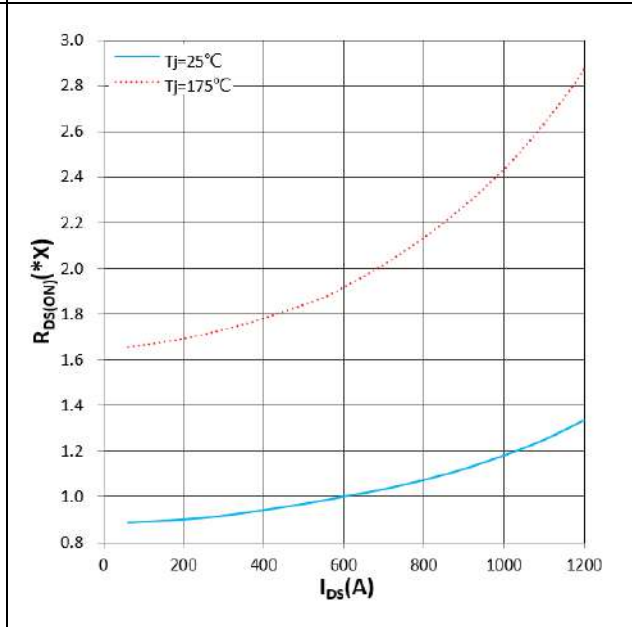


Figure 11. $R_{DS(ON)}$ VS I_{DS}
 $T_J=25^{\circ}\text{C}$, $V_{GS}=+20\text{V}$, $1.0X=3.2\text{m}\Omega$

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

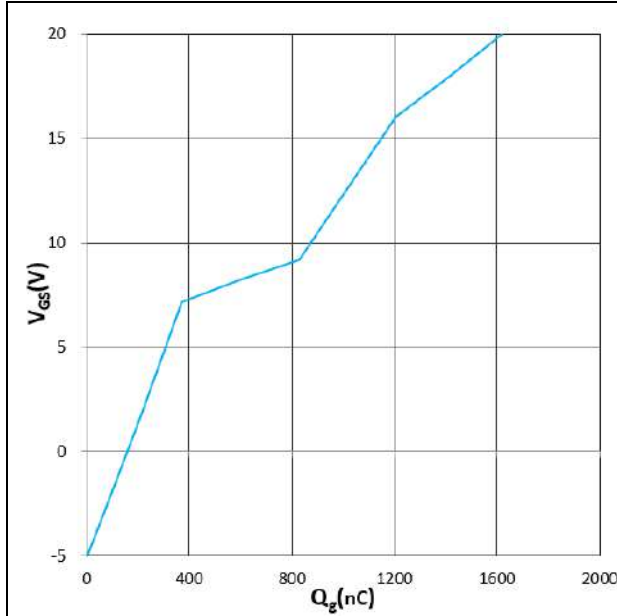


Figure 12. V_{GS} VS Q_g
 $T_j=25^{\circ}\text{C}$, $I_D=300\text{A}$, $V_{DS}=800\text{V}$

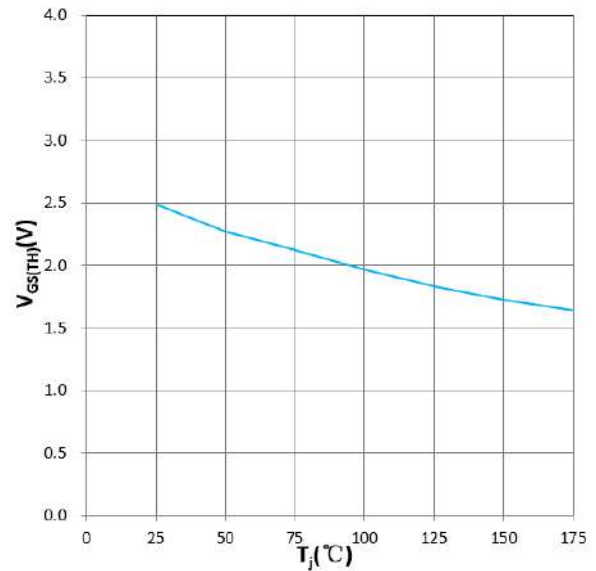


Figure 13. $V_{GS(th)}$ VS T_j
 $V_{GS}=V_{DS}$, $I_D=120\text{mA}$

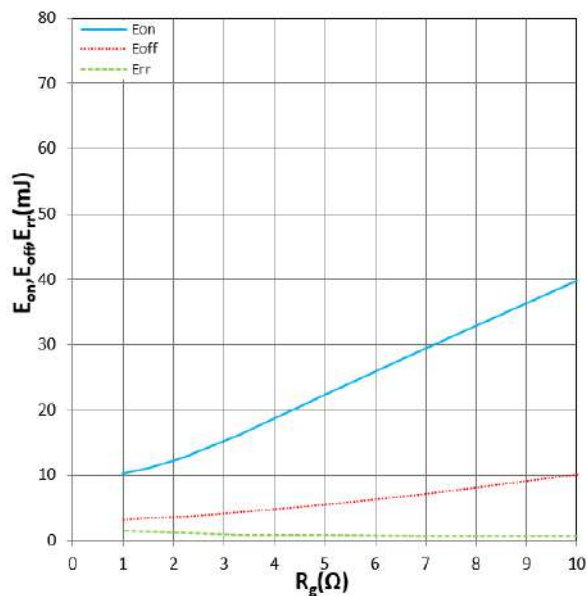


Figure 14. E_{on} , E_{off} , E_{rr} VS R_g
 $T_j=25^{\circ}\text{C}$, $V_{DD}=800\text{V}$, $I_D=600\text{A}$, $\bullet V_{GS}=+18\text{V}/-4\text{V}$
 Inductive Load

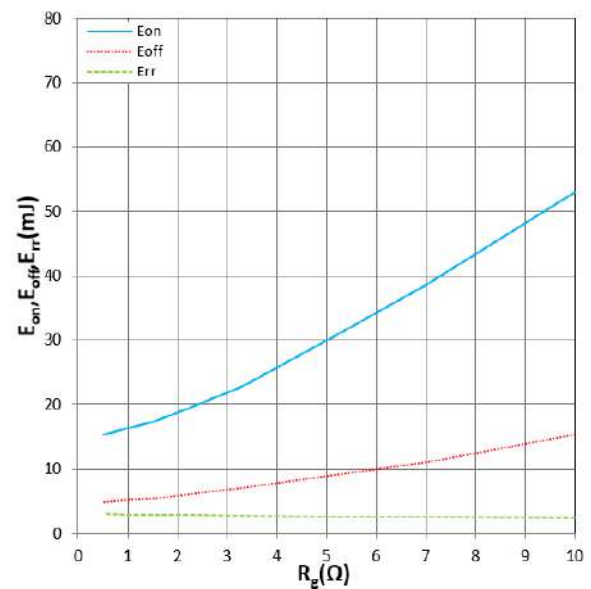


Figure 15. E_{on} , E_{off} , E_{rr} VS R_g
 $T_j=150^{\circ}\text{C}$, $V_{DD}=800\text{V}$, $I_D=600\text{A}$, $\bullet V_{GS}=+18\text{V}/-4\text{V}$
 Inductive Load

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

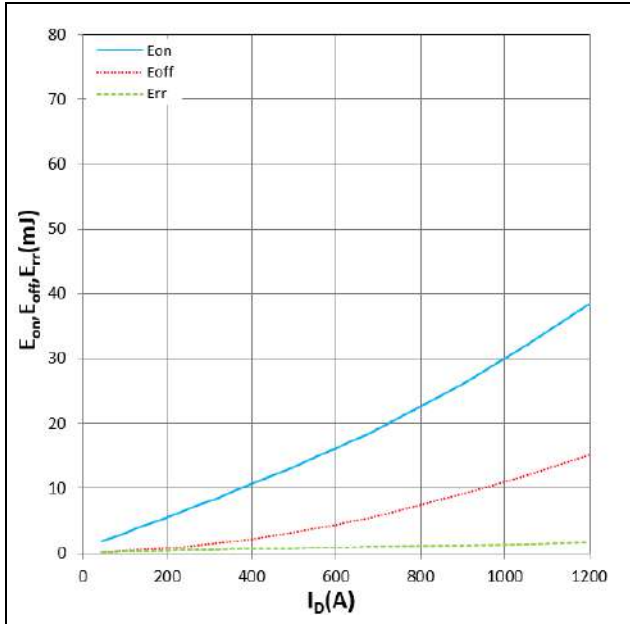


Figure 16. E_{on}, E_{off}, E_{rr} VS I_{DS}
 T_j=25°C, V_{DD}=800V, R_G=3.3Ω, V_{GS}=+18V/-4V
 Inductive Load

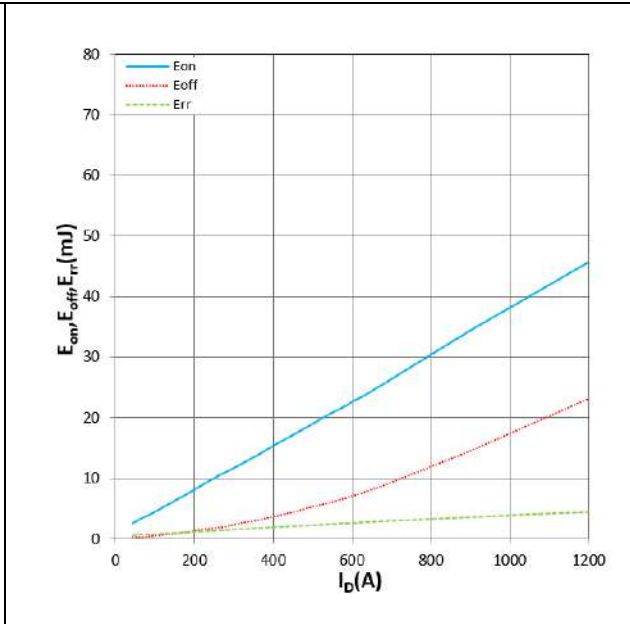


Figure 17. E_{on}, E_{off}, E_{rr} VS I_{DS}
 T_j=150°C, V_{DD}=800V, R_G=3.3Ω, V_{GS}=+18V/-4V
 Inductive Load

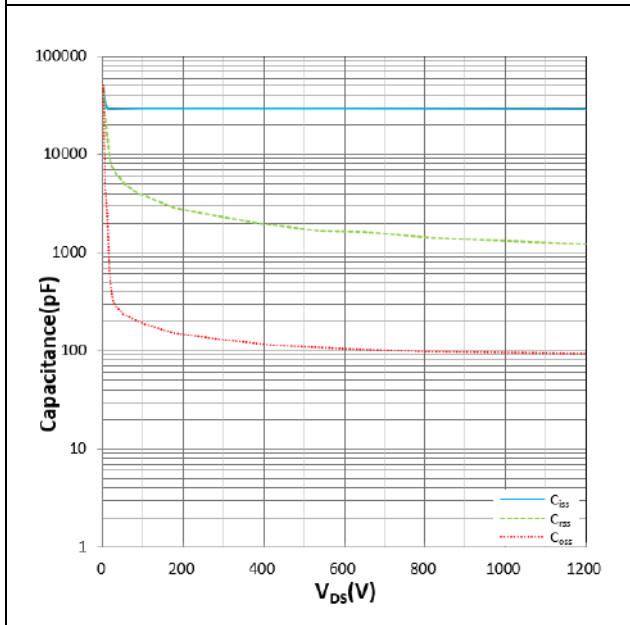


Figure 18. C_{iss}, C_{oss}, C_{rss} VS V_{DS}
 V_{GS}=0V, f=100kHz

HCS03FS140HDA1S

1400V/600A 3 Phase SiC MOSFET Module

IMPORTANT NOTICE

This product data sheet describes the characteristics of this product for which a warranty is granted. Any such warranty is granted exclusively under the terms and conditions of the supply agreement. There will be no guarantee or of any kind for the product and its characteristics.

The data contained in this document is exclusively intended for technically trained staff. You and your technical departments will have to evaluate the product's suitability for the intended application and the completeness of the product data concerning such application.

Due to technical requirements, our product may contain dangerous substances. For information on the types in question, please contact the sales staff responsible for you.

Changes to this product data sheet are reserved.

Please contact the sales staff (sales@hiitio.com) for further information on the product, technology, delivery terms, conditions and prices.

Instruction note

Naming rules for power module product models (Industrial module)

Product Model			
HC	G	02	FF 120 E3 A
Hecheng Code			
Module type G : IGBT module D : FRD module S : SiC module H : Si/SiC hybrid			
On-state resistance (mΩ) 01~80			
Topology structure FZ : A switch unit FF : Half bridge FS : Three phase F4 : H Bridge F3L : Three level DF : Boost Circuit FD : Braking Circuit FP : Rectification+Inverter+Control move AL : ANPC CL : Chopper			
Voltage level (x10) (V) 650~2200			
Packaging form+features (A...Z) A1: 34 mm A2: 62 mm B1: Easy 1B B1A B1B... B2: Easy 2B... B3: Easy 3B... D1: Flow0 D2: Flow1 D3: Flow2 E0 : E0 E1: Econo 2... E2: E2 E3: ED3 E4 : E4 E5 : ED3S E6 : EPM2 E7 : EPM3 E8 : EconoPIM3 E9 : ED3H F0 : F0 P2 : EPM2			
Feature :A: Special Code Nil: Standard			

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